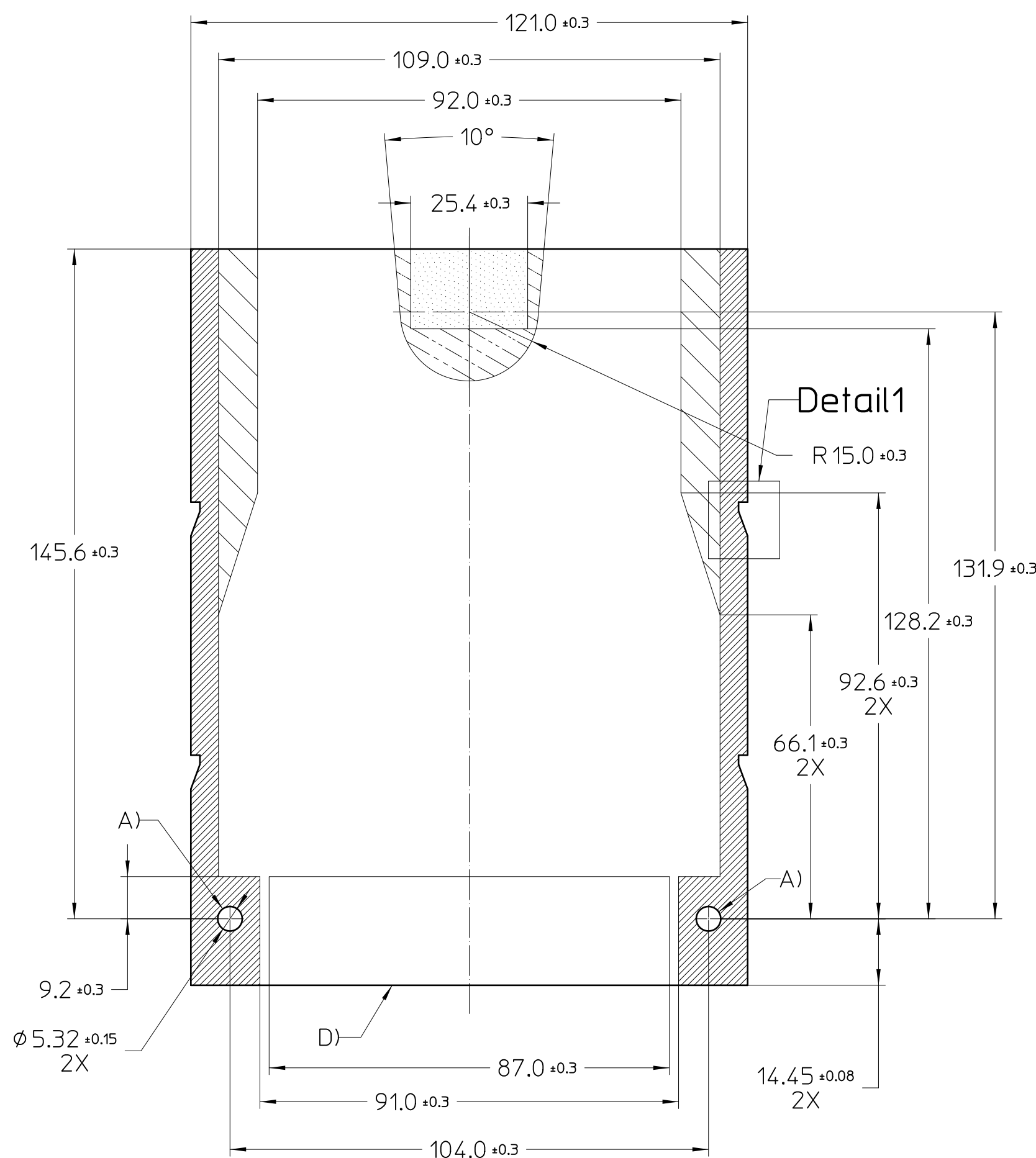


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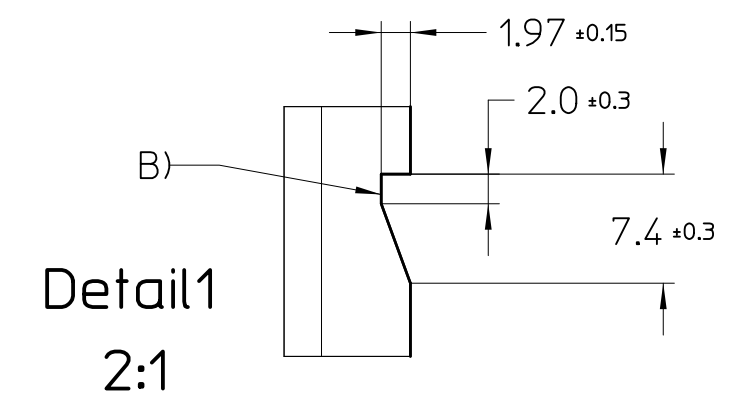
- COMPONENT / TRACE KEEP OUT ZONE
- MAX COMPONENT HEIGHT ABOVE PCB = 12.5
MAX COMPONENT HEIGHT BELOW PCB = 7.5
- MAX COMPONENT HEIGHT ABOVE PCB = 30.5
MAX COMPONENT HEIGHT BELOW PCB = 3.5
- MAX COMPONENT HEIGHT ABOVE PCB = 30.5
MAX COMPONENT HEIGHT BELOW PCB = NO TRACE / COMPONENTS
- MAX COMPONENT HEIGHT ABOVE PCB = 29.5
MAX COMPONENT HEIGHT BELOW PCB = 9.5

GENERAL INFORMATION

- SIMPLIFIED REPRESENTATION
- DOCUMENT EXCLUDED FROM CHANGE PROCESS
- LINEAR DIMENSIONS (MM)
- WEB: WWW.PHOENIXCONTACT.COM WEBCODE: #0857

ADDITIONAL INFORMATION:

- A) PCB MOUNTING HARDWARE HOLE
- B) OPTIONAL CUTOUT FOR ECS-BL (LOCATION & QUANTITY BY CUSTOMER)
- C) PCB THICKNESS = 1.57 MM (.062")
- D) AREA FOR FACEPLATE PCB CONNECTIONS



 DIN A3		document-No. / RI 01048830 / 00		date 13.04.2017	scale 1:1
		ident.-No. 1050209		document-type TECDOC 2D_PCB-Outline	
		description ECS-B-122X169-S-UV-V GY			
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